

C1210C751FFGAC7210

SMD Comm COG HV, Ceramic, 750 pF, 1%, 1500 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1210



Click here for the 3D model.

Dimensions	
Chip Size	1210
L	3.2mm +/-0.2mm
W	2.5mm +/-0.2mm
Т	1.7mm +/-0.20mm
В	0.5mm +/-0.25mm

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	8000
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General Information	
Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	70 mg
Shelf Life	78 Weeks
MSL	1

Specifications				
Capacitance	750 pF			
Measurement Condition	1 MHz 1.0Vrms			
Capacitance Tolerance	1%			
Voltage DC	1500 VDC			
Dielectric Withstanding Voltage	1800 VDC			
Temperature Range	-55/+125°C			
Temperature Coefficient	COG			
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms			
Dissipation Factor	0.1% 1 MHz 1.0Vrms			
Aging Rate	0% Loss/Decade Hour			
Insulation Resistance	100 GOhms			

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